

Description

The API782X are high-performance dual-channel digital isolators with 5700V_{RMS} isolation ratings per UL 1577. This family insulation level can fulfill reinforce and basic isolation requirements, according to VDE, UL, CQC, etc. The data rate of API782X is up to 100Mbps. It provides digital channel direction configuration and the default output level. It can also operate under wide supply voltage of 2.5V to 5.5V.

The API782X provide strong electromagnetic immunity and low emissions at low power consumption. This family has a minimum of 150kV/ μ s common-mode transient immunity (CMTI). The API7820 device has both channels in the same direction while the API7821 device has both channels in the opposite direction. The default output is high for devices without suffix F and low for devices with suffix F. See *Device Functional Modes* section for further details.

Features

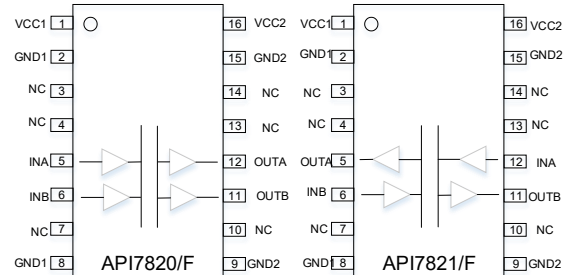
- 100Mbps Data Rate
- Supply Voltage: 2.5V to 5.5V
- $\pm 150\text{kV}/\mu\text{s}$ Minimum CMTI
- CMOS Threshold Inputs
- Default Output High (API782X) and Low (API782XF) Options
- Low-Power Consumption, Typical 2.1mA per Channel at 1Mbps
- Low Propagation Delay: 11ns Typical
- Safety-Related Certifications:
 - 8000V_{PK} Isolation per DIN VDE 0884-17:2021-10
 - 5700V_{RMS} Isolation for 1 Minute per UL 1577
 - CQC Certification per GB 4943.1-2022
- Packaged in SO-16WW (Type CJ)
- Operation Temperature Range -40 to +125°C
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control, (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/quality/product-definitions/) or your local Diodes representative.**
<https://www.diodes.com/quality/product-definitions/>

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Assignments

SO-16WW (Type CJ)



Top View

Applications

- Solar inverters
- Motor control
- Industrial automation
- Power in DATA center/telecom equipment
- Grid, electricity meters

Typical Applications Circuit

The API782X device can be used with MCU, CAN transceiver, bias power supply, and voltage regulator to create an isolated CAN interface. The following is an example circuit of API7821.

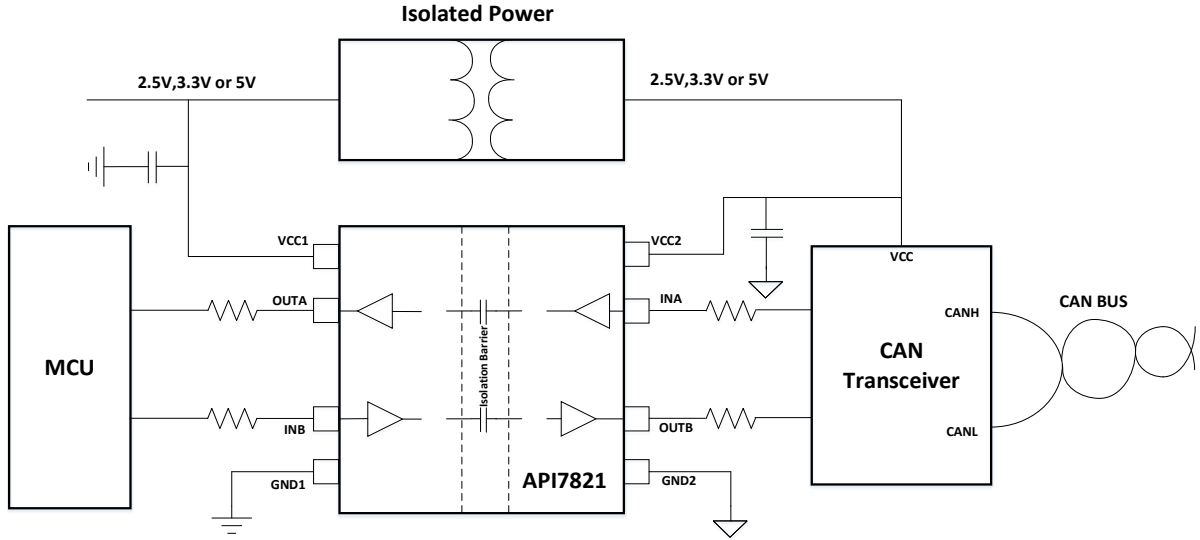


Figure 1. Typical Application Circuit of API782X

Pin Configuration and Descriptions

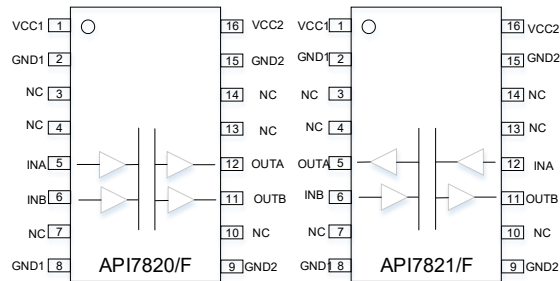


Figure 2. API782X Pin Configuration

Pin Name	Pin Number		Function
	API7820	API7821	
VCC1	1	1	Power supply, VCC1
INA	5	12	Input of Channel A
INB	6	6	Input of Channel B
GND1	2, 8	2, 8	Ground reference for VCC1 side
GND2	9, 15	9, 15	Ground reference for VCC2 side
OUTB	11	11	Output of Channel B
OUTA	12	5	Output of Channel A
VCC2	16	16	Power supply, VCC2
NC	3, 4, 7, 10, 13, 14	3, 4, 7, 10, 13, 14	Not connected

Table 1. Pin Description

Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating	Unit
V_{CC1}, V_{CC2}	Supply Voltage	-0.5 to 6	V
V_{INA}, V_{INB}	Input Signal Voltage	-0.5 to $V_{CC} + 0.5$ (Note 5)	V
V_{OUTA}, V_{OUTB}	Output Signal Voltage	-0.5 to $V_{CC} + 0.5$ (Note 5)	V
I_O	Output Current	-15 to 15	mA
T_J	Operating Junction Temperature Range	-40 to +150	°C
T_{STG}	Storage Temperature Range	-65 to +150	°C
ESD	Human Body Model	8000	V
	Charged Device Model	1600	V
	Contact Discharge per IEC 61000-4-2; Isolation Barrier Withstand Test (Note 6)	8000	V

- Notes:
- Stresses greater than those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability.
 - Maximum voltage must not exceed 6V.
 - IEC ESD strike is applied across the barrier with all pins on each side tied together creating a two-terminal device.

Recommended Operating Conditions

Symbol	Parameter	Min	Typ	Max	Unit
V_{CC1}, V_{CC2}	Power-Supply Voltage	2.5	—	5.5	V
V_{IH}	High-Level Input Voltage	$0.7 \times V_{CC1}$	—	V_{CC1}	V
V_{IL}	Low-Level Input Voltage	0	—	$0.3 \times V_{CC1}$	V
DR	Data Rate	—	—	100	Mbps
T_A	Ambient Temperature	-40	—	+125	°C

Package Thermal Information

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Junction to Ambient Thermal Resistance	59.91	°C/W
$R_{\theta JC(top)}$	Junction to Case Thermal Resistance	25.68	°C/W
$R_{\theta JB}$	Junction-to-Board Thermal Resistance	31.44	°C/W
ψ_{JT}	Junction-to-Top Characterization Parameter	6.90	°C/W
ψ_{JB}	Junction-to-Board Characterization Parameter	30.37	°C/W
$R_{\theta JC(bot)}$	Junction-to-Case (Bottom) Thermal Resistance	35.05	°C/W

Power Ratings

Parameter		Test Conditions	Min	Typ	Max	Unit
API7820						
P _D	Maximum Power Dissipation (Both Sides)	V _{CC1} = V _{CC2} = 5.5V, T _J = +150°C, CL = 15pF, Input 50MHz 50% duty cycle square wave	—	—	154	mW
P _{D1}	Maximum Power Dissipation (Side-1)		—	—	27.5	mW
P _{D2}	Maximum Power Dissipation (Side-2)		—	—	126.5	mW
API7821						
P _D	Maximum Power Dissipation (Both Sides)	V _{CC1} = V _{CC2} = 5.5V, T _J = +150°C, CL = 15pF, Input 50MHz 50% duty cycle square wave	—	—	165	mW
P _{D1}	Maximum Power Dissipation (Side-1)		—	—	82.5	mW
P _{D2}	Maximum Power Dissipation (Side-2)		—	—	82.5	mW

Insulation Specifications

Symbol	Parameter	Condition	Value	Unit
CLR	External Clearance	Shortest terminal-to-terminal distance through air	15	mm
CPG	External Creepage	Shortest terminal-to-terminal distance across the package surface	15	mm
DTI	Distance Through the Insulation	Minimum internal gap (internal clearance)	26	μm
CTI	Comparative Tracking Index	DIN EN 60112 (VDE 0303-11); IEC 60112	> 600	V
—	Material Group	According to IEC 60664-1	I	—
—	For Rated Mains Voltage ≤ 150V _{RMS}	—	I to IV	—
—	For Rated Mains Voltage ≤ 300V _{RMS}	—	I to IV	—
—	For Rated Mains Voltage ≤ 600V _{RMS}	—	I to IV	—
—	For Rated Mains Voltage ≤ 1000V _{RMS}	—	I to III	—
DIN V VDE 0884-11 (VDE V 0884-11): 2017-01				
V _{IORM}	Maximum Repetitive Peak Isolation Voltage	AC voltage	2121	V _{PK}
V _{IOWM}	Maximum Working Isolation Voltage	AC voltage	1500	V _{RMS}
		DC voltage	2121	V _{DC}
V _{IOTM}	Maximum Transient Isolation Voltage	V _{TEST} = V _{IOTM} , t = 60s (qualification) V _{TEST} = 1.2 × V _{IOTM} , t = 1s (100% production)	8000	V _{PK}
V _{IMP}	Maximum Impulse Voltage	Tested in air, 1.2/50μs waveform per IEC 62368-1	8000	V _{PK}
V _{IOSM}	Maximum Surge Isolation Voltage	V _{IOSM} ≥ 1.6 × V _{IMP} ; Tested in oil (qualification test), 1.2/50μs waveform, per IEC 62368-1	12800	V _{PK}
Q _{pd}	Apparent Charge	Method a, After I/O safety test subgroup 2/3. V _{ini} = V _{IOTM} , t _{ini} = 60s; V _{pd(m)} = 1.2 × V _{IORM} , t _m = 10s	< 5	pC
		Method a, After environmental tests subgroup 1. V _{ini} = V _{IOTM} , t _{ini} = 60s; V _{pd(m)} = 1.6 × V _{IORM} , t _m = 10s	< 5	pC
		Method b1; At routine test (100% production) and preconditioning (type test) V _{ini} = 1.2 × V _{IOTM} ; t _{ini} = 1s; V _{pd(m)} = 1.875 × V _{IORM} , t _m = 1s	< 5	pC
C _{IO}	Barrier Capacitance, Input to Output	V _{IO} = 0.4 sin (2πft), f = 1MHz	~0.5	pF
R _{IO}	Isolation Resistance, Input to Output	V _{IO} = 500V at T _A = +25°C	> 10 ¹²	Ω
R _{IO}	Isolation Resistance, Input to Output	V _{IO} = 500V at +100°C ≤ T _A ≤ +125°C	> 10 ¹¹	
R _{IO}	Isolation Resistance, Input to Output	V _{IO} = 500V at T _S = +150°C	> 10 ⁹	
Pollution Degree	—	—	2	—
Climatic Category	—	—	55/125/21	—
UL1577				
V _{ISO}	Withstand Isolation Voltage	V _{TEST} = V _{ISO} , t = 60s (qualification), V _{TEST} = 1.2 × V _{ISO} , t = 1s (100% production)	5700	V _{RMS}

Safety-Related Certifications

VDE	UL	CQC
DIN VDE 0884-17:2021-10	UL 1577	GB 4943.1-2022
Maximum transient isolation voltage, 8000V _{PK} Maximum repetitive peak isolation voltage, 2121V _{PK} Maximum surge isolation voltage, 12800V _{PK}	Single protection, 5700V _{RMS}	Reinforced insulation, Altitude ≤ 5000m, tropical climate, 700V _{RMS} maximum working voltage
Certification planned	File Number: E550819	Certification planned

Safety-Limiting Values

Symbol	Parameter	Condition	Value	Unit
I _S	Safety Supply Current	V _{CC} = 5.5V, T _J = +150°C, T _A = +25°C	379	mA
P _S	Safety Supply Power	T _J = +150°C, T _A = +25°C	2086	mW
T _S	Safety Temperature	—	+150	°C

Electrical Characteristics ($V_{CC1} = V_{CC2}$, $T_A = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$. Unless otherwise noted, typical values are at $T_A = +25^{\circ}\text{C}$)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
$V_{CC}(\text{UVLOP})$	UVLO Threshold When Supply Voltage is Rising	—	—	2.2	—	V
$V_{CC}(\text{UVLON})$	UVLO Threshold When Supply Voltage is Falling	—	—	2.1	—	V
$V_{HYS}(\text{UVLO})$	Supply Voltage UVLO Hysteresis	—	—	100	—	mV
V_{OH}	High-Level Output Voltage	$I_O \leq 4\text{mA}$	$V_{CCO} - 0.4$	—	—	V
V_{OL}	Low-Level Output Voltage	$I_O \leq 4\text{mA}$	—	—	0.4	V
$V_{IT+}(\text{IN})$	Rising Input Threshold Voltage	—	—	$0.6 \times V_{CCI}$	$0.7 \times V_{CCI}$	V
$V_{IT-}(\text{IN})$	Falling Input Threshold Voltage	—	$0.3 \times V_{CCI}$	$0.4 \times V_{CCI}$	—	V
$V_{I(HYS)}$	Input Threshold Voltage Hysteresis	—	$0.1 \times V_{CCI}$	$0.2 \times V_{CCI}$	—	V
I_{IH}	High-Level Input Current	$V_{IH} = V_{CCI}$ at IN_x	—	—	15	μA
I_{IL}	Low-Level Input Current	$V_{IL} = 0$ at IN_x	-15	—	—	μA
CMTI	Common-Mode Transient Immunity (Note 7)	$V_I = V_{CCI}$ or 0, $V_{CM} = 1200\text{V}$	150	—	—	$\text{kV}/\mu\text{s}$

Note: 7. Parameter is not subject to production test - verified by design/characterization.

Supply Current Characteristics – 5V Supply ($V_{CC1} = V_{CC2} = 5\text{V} \pm 10\%$, $T_A = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$. Unless otherwise noted, Typical values are at $T_A = +25^{\circ}\text{C}$.)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
API7820, API7820F						
I _{CC1(0)}	Supply Current - DC Signal	V _I = V _{CCI} (API7820), V _I = 0 (API7820F)	—	0.80	1.19	mA
I _{CC2(0)}		—	1.80	2.88		
I _{CC1(1)}		V _I = 0 (API7820), V _I = V _{CCI} (API7820F)	—	3.15	4.55	
I _{CC2(1)}		—	1.84	2.85		
I _{CC1(1M)}	Supply Current - AC Signal	All channels switching with 1Mbps square wave clock input; CL = 15pF	—	1.96	2.76	
I _{CC2(1M)}		—	2.0	3.04		
I _{CC1(10M)}		All channels switching with 10Mbps square wave clock input; CL = 15pF	—	1.97	2.86	
I _{CC2(10M)}		—	3.49	4.5		
I _{CC1(100M)}		All channels switching with 100Mbps square wave clock input; CL = 15pF	—	2.26	4.00	
I _{CC2(100M)}		—	16.88	24.08		
API7821, API7821F						
I _{CC1(0)} , I _{CC2(0)}	Supply Current - DC Signal	V _I = V _{CCI} (API7821) V _I = 0 (API7821F)	—	1.48	1.91	mA
I _{CC1(1)} , I _{CC2(1)}		V _I = 0 (API7821) V _I = V _{CCI} (API7821F)	—	2.74	3.71	
I _{CC1(1M)} , I _{CC2(1M)}	Supply Current - AC Signal	All channels switching with 1Mbps square wave clock input; CL = 15pF	—	2.10	2.87	
I _{CC1(10M)} , I _{CC2(10M)}		All channels switching with 10Mbps square wave clock input; CL = 15pF	—	2.89	3.83	
I _{CC1(100M)} , I _{CC2(100M)}		All channels switching with 100Mbps square wave clock input; CL = 15pF	—	10.16	12.25	

Supply Current Characteristics – 3.3V Supply ($V_{CC1} = V_{CC2} = 3.3V \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Unless otherwise noted, typical values are at $T_A = +25^\circ\text{C}$)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
API7820, API7820F						
I _{CC1(0)}	Supply Current - DC Signal	V _I = V _{CCI} (API7820), V _I = 0 (API7820F)	—	0.64	0.91	mA
I _{CC2(0)}			—	1.62	2.81	
I _{CC1(1)}		V _I = 0 (API7820), V _I = V _{CCI} (API7820F)	—	2.98	4.25	
I _{CC2(1)}			—	1.67	2.77	
I _{CC1(1M)}	Supply Current - AC Signal	All channels switching with 1Mbps square wave clock input; CL = 15pF	—	1.79	2.62	
I _{CC2(1M)}			—	1.75	2.92	
I _{CC1(10M)}		All channels switching with 10Mbps square wave clock input; CL = 15pF	—	1.80	2.66	
I _{CC2(10M)}			—	2.75	4.26	
I _{CC1(100M)}		All channels switching with 100Mbps square wave clock input; CL = 15pF	—	2.17	3.63	
I _{CC2(100M)}			—	12.88	16.53	
API7821, API7821F						
I _{CC1(0)} , I _{CC2(0)}	Supply Current - DC Signal	V _I = V _{CCI} (API7821) V _I = 0 (API7821F)	—	1.32	1.77	mA
I _{CC1(1)} , I _{CC2(1)}		V _I = 0 (API7821) V _I = V _{CCI} (API7821F)	—	2.56	3.57	
I _{CC1(1M)} , I _{CC2(1M)}	Supply Current - AC Signal	All channels switching with 1Mbps square wave clock input; CL = 15pF	—	1.95	2.68	
I _{CC1(10M)} , I _{CC2(10M)}		All channels switching with 10Mbps square wave clock input; CL = 15pF	—	2.47	3.33	
I _{CC1(100M)} , I _{CC2(100M)}		All channels switching with 100Mbps square wave clock input; CL = 15pF	—	6.77	9.67	

Supply Current Characteristics – 2.5V Supply ($V_{CC1} = V_{CC2} = 2.5V \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Unless otherwise noted, typical values are at $T_A = +25^\circ\text{C}$.)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
API7820, API7820F						
I _{CC1(0)}	Supply Current - DC Signal	V _I = V _{CCI} (API7820), V _I = 0 (API7820F)	—	0.62	0.89	mA
I _{CC2(0)}		—	1.60	2.78		
I _{CC1(1)}		V _I = 0 (API7820), V _I = V _{CCI} (API7820F)	—	2.95	4.32	
I _{CC2(1)}		—	1.64	2.76		
I _{CC1(1M)}	Supply Current - AC Signal	All channels switching with 1Mbps square wave clock input; CL = 15pF	—	1.76	2.58	
I _{CC2(1M)}			—	1.70	2.87	
I _{CC1(10M)}		All channels switching with 10Mbps square wave clock input; CL = 15pF	—	1.78	2.62	
I _{CC2(10M)}			—	2.46	3.96	
I _{CC1(100M)}		All channels switching with 100Mbps square wave clock input; CL = 15pF	—	2.15	3.40	
I _{CC2(100M)}			—	10.42	13.53	
API7821, API7821F						
I _{CC1(0)} , I _{CC2(0)}	Supply Current - DC Signal	V _I = V _{CCI} (API7821), V _I = 0 (API7821F)	—	1.30	1.72	mA
I _{CC1(1)} , I _{CC2(1)}		V _I = 0 (API7821) V _I = V _{CCI} (API7821F)	—	2.54	3.53	
I _{CC1(1M)} , I _{CC2(1M)}	Supply Current - AC Signal	All channels switching with 1Mbps square wave clock input; CL = 15pF	—	1.97	2.68	
I _{CC1(10M)} , I _{CC2(10M)}		All channels switching with 10Mbps square wave clock input; CL = 15pF	—	2.36	3.79	
I _{CC1(100M)} , I _{CC2(100M)}		All channels switching with 100Mbps square wave clock input; CL = 15pF	—	5.73	8.03	

Switching Characteristics – 5V Supply

($V_{CC1} = V_{CC2} = 5V \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Unless otherwise noted, typical values are at $T_A = +25^\circ\text{C}$.)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
t_{PLH} , t_{PHL}	Propagation Delay Time	—	—	10	17	ns
PWD	Pulse Width Distortion $ t_{PHL} - t_{PLH} $	—	—	0.5	5	ns
$t_{sk(o)}$	Channel-to-Channel Output Skew Time (Note 8)	Same direction channels	—	—	4	ns
$t_{sk(pp)}$	Part-to-Part Skew Time (Note 9)	—	—	—	5	ns
t_r	Output Signal Rise Time	—	—	—	5	ns
t_f	Output Signal Fall Time	—	—	—	5	ns
MPW	Minimum Pulse Width	—	—	—	10	ns
$t_{JIT(PK)}$	Peak Eye Diagram Jitter (Note 10)	—	—	350	—	ps

Switching Characteristics – 3.3V Supply

($V_{CC1} = V_{CC2} = 3.3V \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Unless otherwise noted, typical values are at $T_A = +25^\circ\text{C}$.)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
t_{PLH} , t_{PHL}	Propagation Delay Time	—	—	10.5	18.5	ns
PWD	Pulse Width Distortion $ t_{PHL} - t_{PLH} $	—	—	0.5	5	ns
$t_{sk(o)}$	Channel-to-Channel Output Skew Time (Note 8)	Same direction channels	—	—	4	ns
$t_{sk(pp)}$	Part-to-Part Skew Time (Note 9)	—	—	—	5	ns
t_r	Output Signal Rise Time	—	—	—	5	ns
t_f	Output Signal Fall Time	—	—	—	5	ns
MPW	Minimum Pulse Width	—	—	—	10	ns
$t_{JIT(PK)}$	Peak Eye Diagram Jitter (Note 10)	—	—	350	—	ps

Switching Characteristics – 2.5V Supply

($V_{CC1} = V_{CC2} = 2.5V \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Unless otherwise noted, typical values are at $T_A = +25^\circ\text{C}$.)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
t_{PLH} , t_{PHL}	Propagation Delay Time	—	—	11	21	ns
PWD	Pulse Width Distortion $ t_{PHL} - t_{PLH} $	—	—	0.5	5	ns
$t_{sk(o)}$	Channel-to-Channel Output Skew Time (Note 8)	Same direction channels	—	—	4	ns
$t_{sk(pp)}$	Part-to-Part Skew Time (Note 9)	—	—	—	5	ns
t_r	Output Signal Rise Time	—	—	—	5	ns
t_f	Output Signal Fall Time	—	—	—	5	ns
MPW	Minimum Pulse Width	—	—	—	10	ns
$t_{JIT(PK)}$	Peak Eye Diagram Jitter (Note 10)	—	—	350	—	ps

- Notes:
- $t_{sk(o)}$ is the skew between outputs of a single device with all inputs connected and outputs switching in the same direction with same loads.
 - $t_{sk(pp)}$ is the magnitude of the difference in propagation delay times between any terminals of different devices switching in the same direction while operating at identical supply voltages, temperature, input signals and loads.
 - Parameter is not subject to production test - verified by design/characterization.

Insulation Characteristics Curves

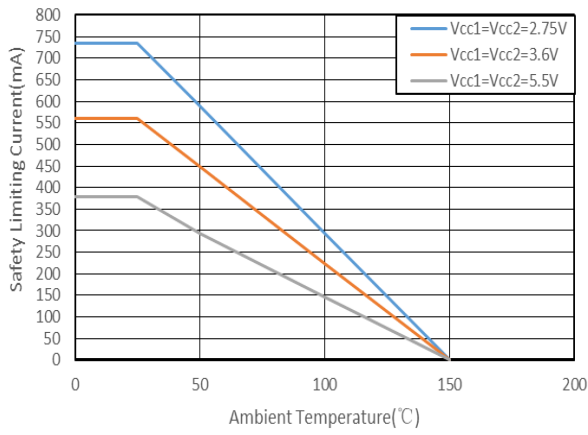


Figure 3. Thermal Derating Curve for Limiting Current

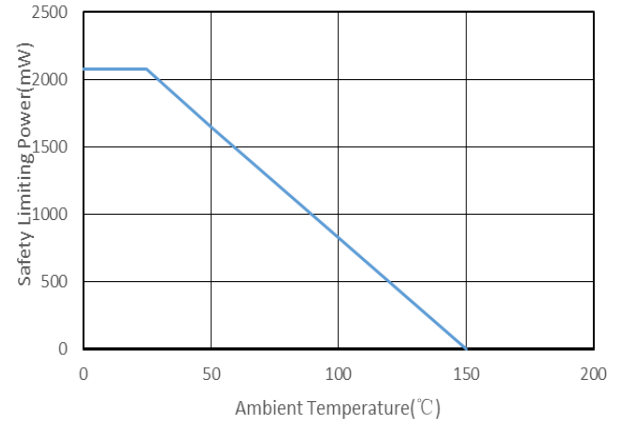
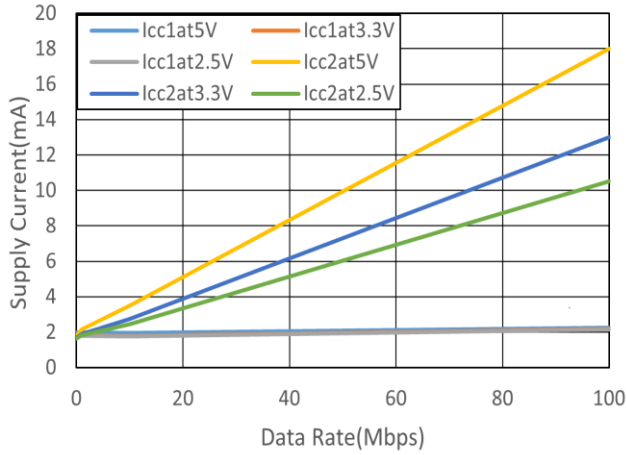
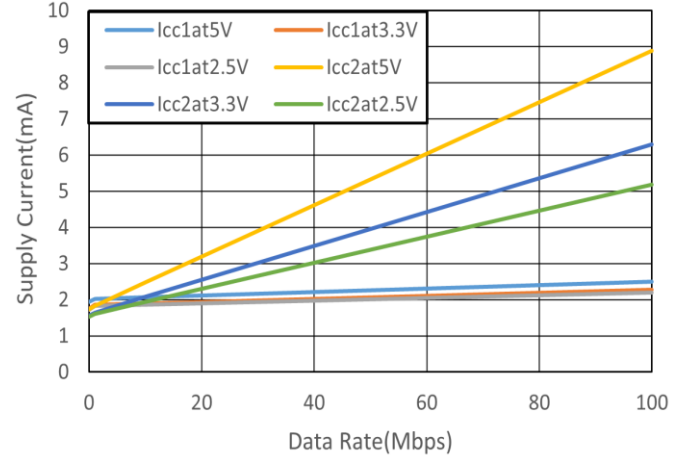


Figure 4. Thermal Derating Curve for Limiting Power

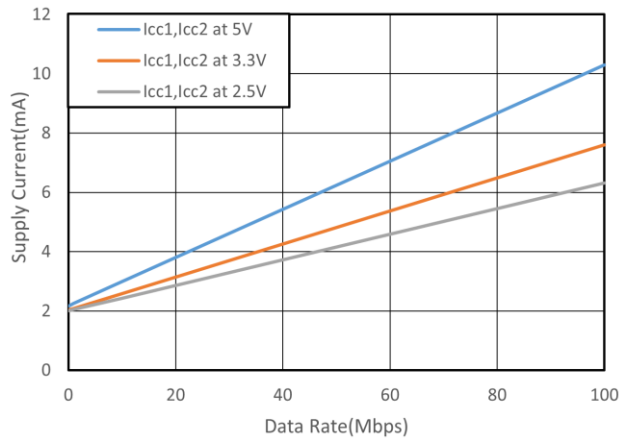
Typical Characteristics



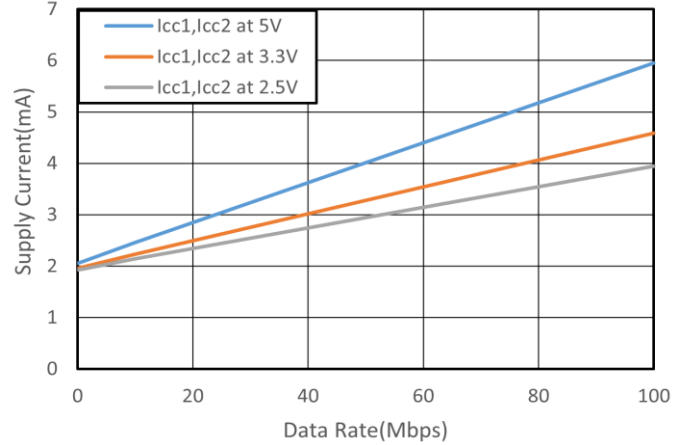
$T_A = +25^\circ\text{C}$ $CL = 15\text{pF}$
Figure 5. API7820 Supply Current vs. Data Rate
(With 15pF Load)



$T_A = +25^\circ\text{C}$ $CL = \text{No Load}$
Figure 6. API7820 Supply Current vs. Data Rate
(With No Load)



$T_A = +25^\circ\text{C}$ $CL = 15\text{pF}$
Figure 7. API7821 Supply Current vs. Data Rate
(With 15pF Load)



$T_A = +25^\circ\text{C}$ $CL = \text{No Load}$
Figure 8. API7821 Supply Current vs. Data Rate
(With No Load)

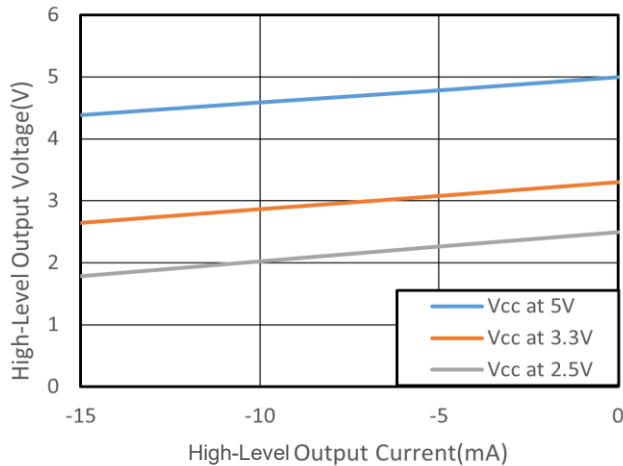


Figure 9. High-Level Output Voltage vs. High-level
Output Current

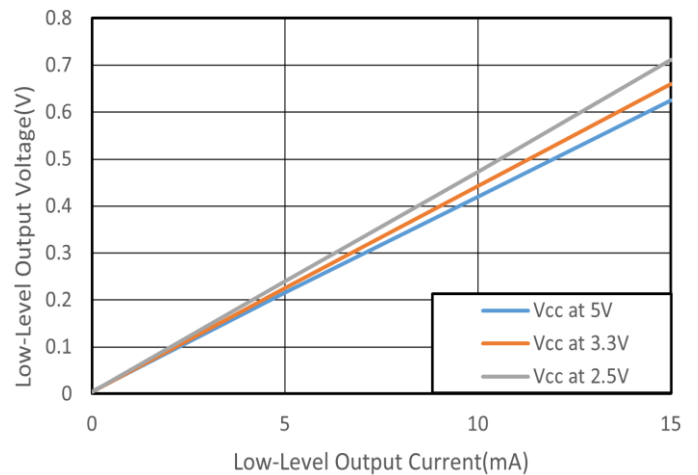


Figure 10. Low-Level Output Voltage vs. Low-Level
Output Current

Typical Characteristics (continued)

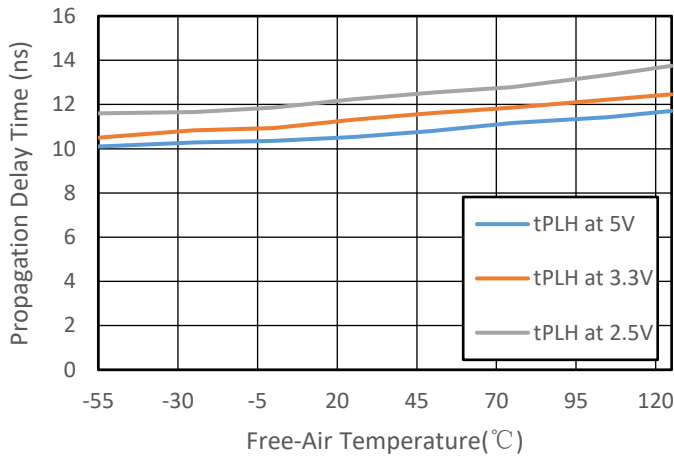


Figure 11. Propagation Delay Time vs. Free-Air Temperature

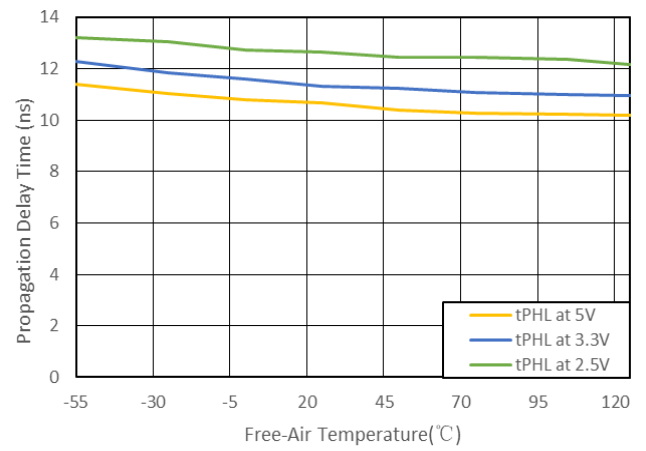


Figure 12. Propagation Delay Time vs. Free-Air Temperature

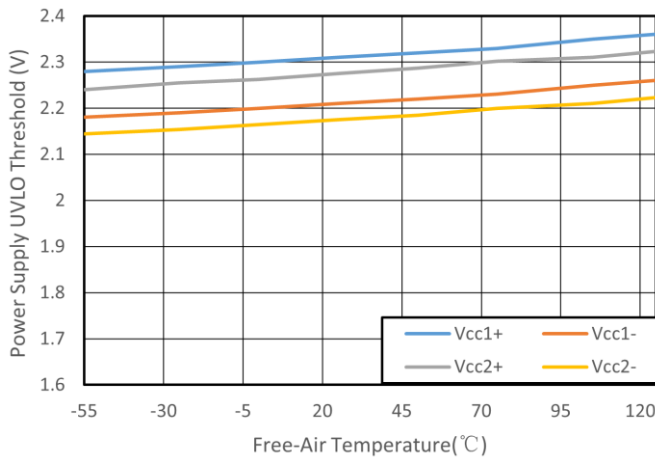
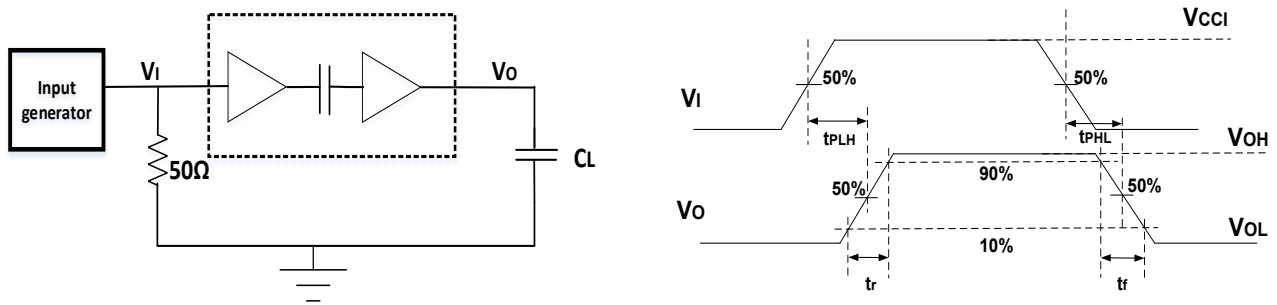


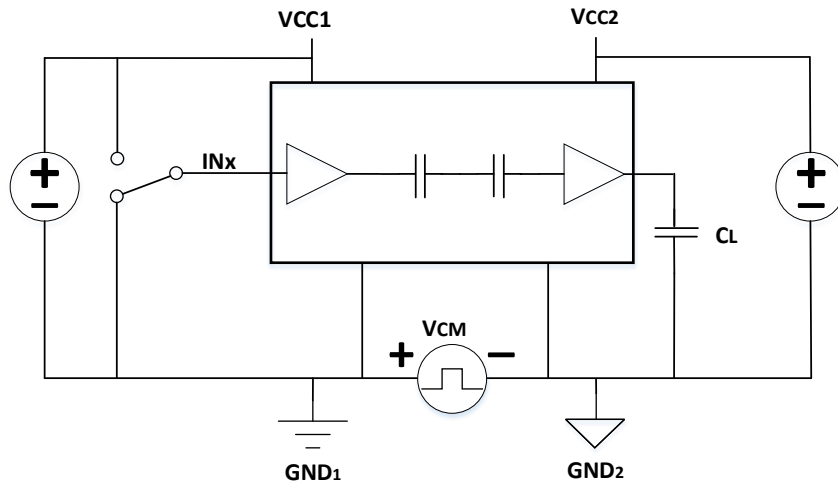
Figure 13. Power-Supply Undervoltage Threshold vs. Free-Air Temperature

Parameter Measurement



- A. The input pulse is supplied by a generator having the following characteristics: PRR $\leq$ 50kHz, 50% duty cycle, $t_r \leq$ 3ns, $t_f \leq$ 3ns, $Z_O = 50\Omega$.
At the input, 50Ω resistor is required to terminate input generator signal. It is not needed in actual application.
B. $CL = 15pF$ and includes instrumentation and fixture capacitance within $\pm 20\%$.

Figure 14. Switching Characteristics Test Circuit and Voltage Waveforms



- A. $CL = 15pF$ and includes instrumentation and fixture capacitance within $\pm 20\%$.

Figure 15. Common-Mode Transient Immunity Test Circuit

Operation Description

Overview

The API782X/API782XF family of devices is dual-channel isolator based on ON-OFF keying (OOK) modulation scheme to transfer digital data through capacitive isolation barrier. The different state of digital data was modulated with high frequency carrier at the transmitter side and demodulated at receiver side by advanced signal process technique, and the accomplished circuit technique were incorporated to enhance the CMTI performance and minimize the influence of radiated emissions.

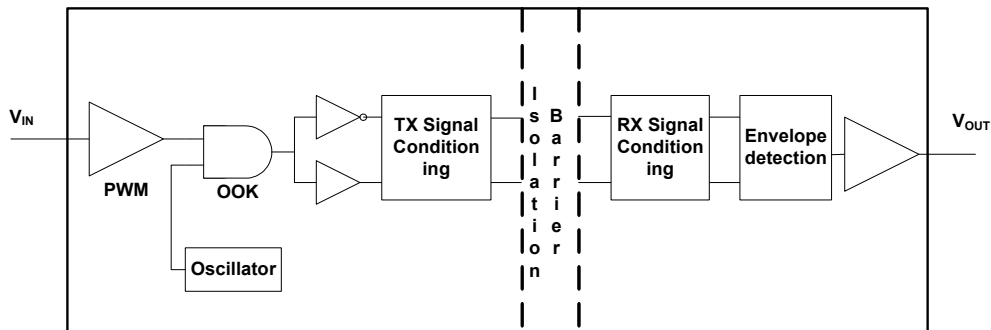


Figure 16. API782X Internal Block Diagram

Operation Description (continued)

A concept of OOK modulation scheme works:

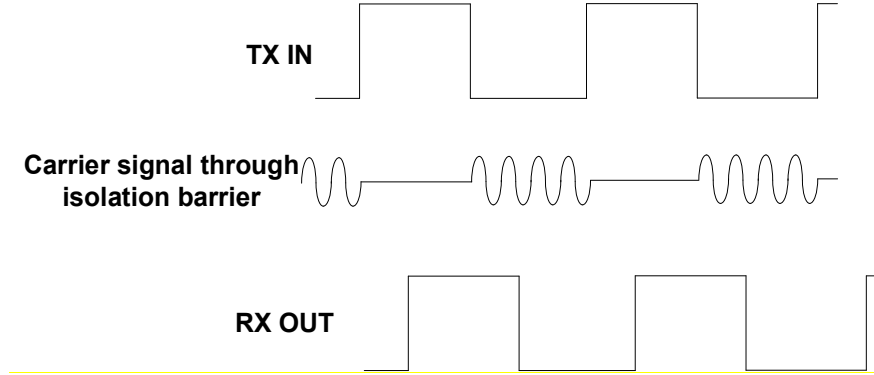


Figure 17. ON-OFF Keying (OOK) Modulation Scheme

Device Functional Modes:

Below table lists the functional modes for the API782X devices.

Input	V _{CCI} Status	V _{CCO} Status	Output	Comment
H	Ready	Ready	H	Normal operation.
L	Ready	Ready	L	
AO	Ready	Ready	Default	Default mode: When INx is open, the corresponding channel output goes to the default logic state. The default is high for API7820/21 and low for API7820F/21F.
X	Unready	Ready	Default	Default mode: When V _{CCI} is unpowered, a channel output assumes the logic state based on the selected default option. The default is high for API7820/21 and low for API7820F/21F. When V _{CCI} transitions from unpowered to powered-up, a channel output assumes the logic state of the input. When V _{CCI} transitions from powered-up to unpowered, a channel output assumes the selected default state.
X	X	Unready	Undetermined	When V _{CCO} is unpowered, a channel output is undetermined. When V _{CCO} transitions from unpowered to powered-up, a channel output assumes the logic state of the input.

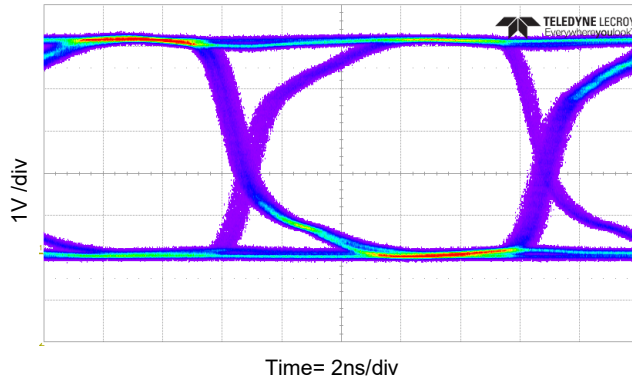
Note: H = Logic High; L = Logic Low; O = Left Open; X = Irrelevant.

Table 2. API782X Function Table

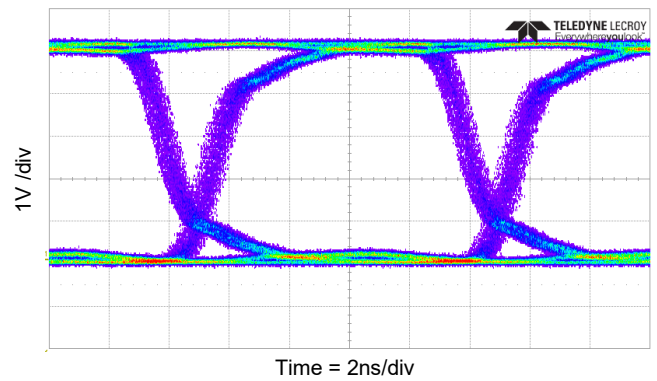
Application and Implementation

Application Curve

The following typical eye diagrams of the API782X family of devices indicate low jitters and wide open eye at the maximum data rate of 100Mbps.



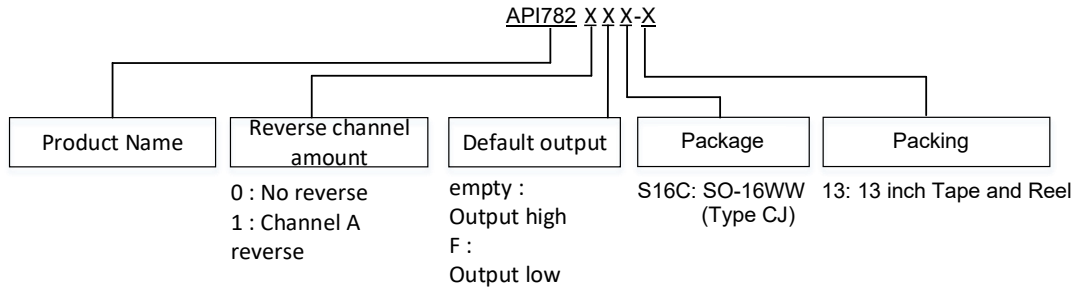
API7820 Eye Diagram at 100Mbps, 5V Supplies and +25°C



API7821 Eye Diagram at 100Mbps, 5V Supplies and +25°C

Figure 18. API7820/21 Eye Diagram

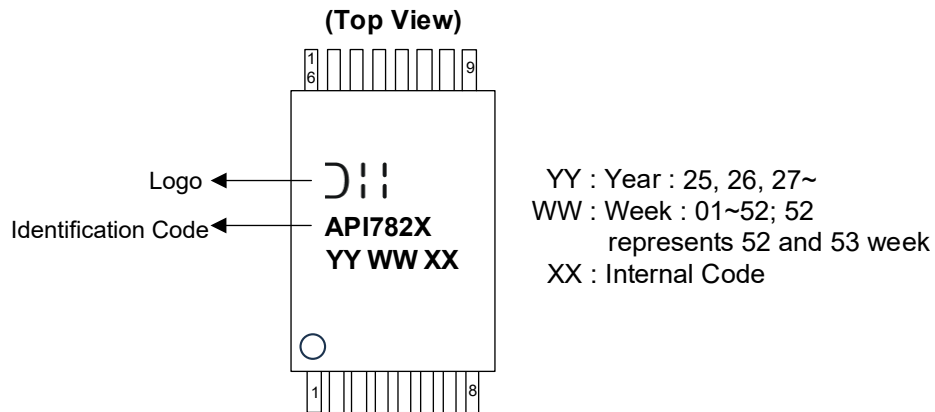
Ordering Information (Note 11)



Orderable Part Number	Marking ID	Package	Packing	
			Qty.	Carrier
API7820S16C-13	API7820	SO-16WW (Type CJ)	1000	13" Tape and Reel
API7821S16C-13	API7821	SO-16WW (Type CJ)	1000	13" Tape and Reel
API7820FS16C-13	API7820F	SO-16WW (Type CJ)	1000	13" Tape and Reel
API7821FS16C-13	API7821F	SO-16WW (Type CJ)	1000	13" Tape and Reel

Note: 11. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

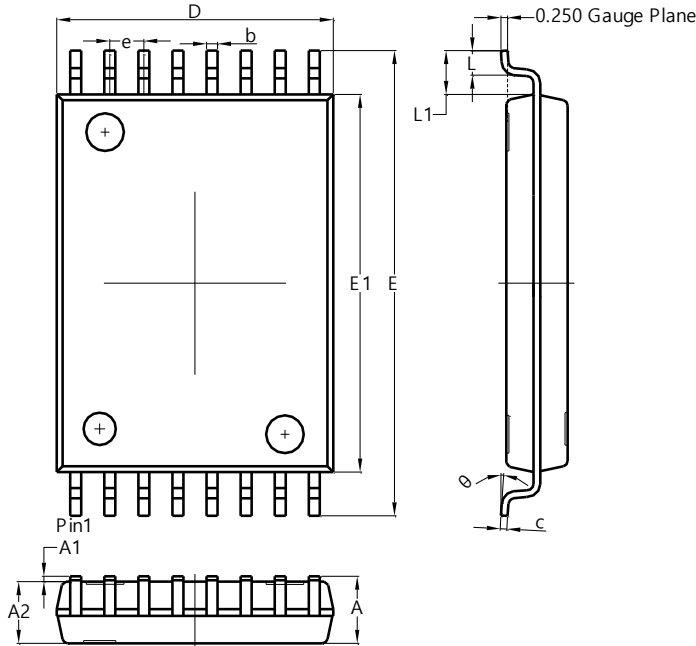
Marking Information



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SO-16WW (Type CJ)

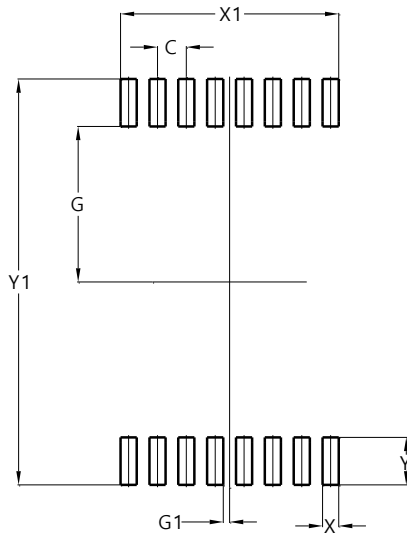


SO-16WW (Type CJ)			
Dim	Min	Max	Typ
A	--	2.650	--
A1	0.100	0.300	--
A2	2.236	2.336	--
b	0.310	0.510	--
c	0.220	0.280	--
D	10.200	10.400	--
E	17.100	17.400	--
E1	13.900	14.100	--
e	1.270 BSC		
L	0.600	1.100	--
L1	1.625 REF		
θ	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SO-16WW (Type CJ)



Dimensions	Value (in mm)
C	1.270
G	6.800
G1	0.280
X	0.710
X1	9.600
Y	2.075
Y1	17.750

Mechanical Data

- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per JESD22-B102 ③
- Weight: 0.468 grams (Approximate)

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